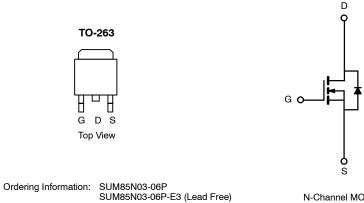




N-Channel 30-V (D-S) 175°C MOSFET

PRODUCT SUMMARY				
V _{(BR)DSS} (V)	$r_{DS(on)}\left(\Omega\right)$	I _D (A)		
30	0.006 @ V _{GS} = 10 V	85		
	0.009 @ V _{GS} = 4.5 V	77		



FEATURES

- TrenchFET® Power MOSFET
- 175°C Junction Temperature
- PWM Optimized for High Efficiency
- New Package with Low Thermal Resistance
- 100% R_g Tested

APPLICATIONS

- Buck Converter
 - High Side
 - Low Side
- Synchronous Rectifier
 - Secondary Rectifier

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^{\circ}C$ UNLESS OTHERWISE NOTED)					
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	30		
Gate-Source Voltage		V _{GS}	±20	V	
0 11 0 15 17500	T _C = 25°C		85		
Continuous Drain Current (T _J = 175°C)	T _C = 100°C	I _D	67		
Pulsed Drain Current		I _{DM}	200	A	
Avalanche Current		I _{AR}	45		
Repetitive Avalanche Energy ^a	L = 0.1 mH	E _{AR}	101	mJ	
Maximum Power Dissipation ^a	T _C = 25°C	D	100 ^b	w	
	T _A = 25°C°	P _D	3.75		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol Limit		Unit	
Junction-to-Ambient	PCB Mount ^c	R _{thJA}	40	°C/W	
	Free Air		62.5		
Junction-to-Case		R _{thJC}	1.5		

Notes

- Duty cycle \leq 1%.
- See SOA curve for voltage derating.
 When mounted on 1" square PCB (FR-4 material).

SUM85N03-06P

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SPECIFICATIONS (T _J =2			N4:	T		11	
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{DS} = 0 \text{ V, } I_{D} = 250 \mu\text{A}$	30			V	
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1		3.0	1 '	
Gate-Body Leakage	I _{GSS}	V_{DS} = 0 V, V_{GS} = ±20 V			±100	nA	
Zero Gate Voltage Drain Current		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ	
	I _{DSS}	V_{DS} = 30 V, V_{GS} = 0 V, T_J = 125°C			50		
		V_{DS} = 30 V, V_{GS} = 0 V, T_J = 175°C			250	1	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	120			Α	
		$V_{GS} = 10 \text{ V}, I_{D} = 20 \text{ A}$		0.0045	0.006		
		V _{GS} = 10 V, I _D = 20 A, T _J = 125°C			0.0085	Ω	
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = 10 V, I _D = 20 A, T _J = 175°C			0.011		
		V_{GS} = 4.5 V, I_D = 20 A		0.0072	0.009		
Forward Transconductancea	9 _{fs}	$V_{DS} = 15 \text{ V}, I_D = 20 \text{ A}$	20			S	
Dynamic ^b	<u> </u>			•		•	
Input Capacitance	C _{iss}			3100		pF	
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz		565			
Reverse Transfer Capacitance	C _{rss}			255			
Gate-Resistance	R _g		0.5	1.9	3.1	Ω	
Total Gate Charge ^b	Qg			48	65		
Gate-Source Charge ^b	Q _{gs}	$V_{DS} = 15 \text{ V}, \ V_{GS} = 10 \text{ V}, \ I_D = 50 \text{ A}$		10		nC	
Gate-Drain Charge ^b	Q _{gd}			7.5			
Turn-On Delay Time ^b	t _{d(on)}			12	20		
Rise Time ^b	t _r	$V_{DD} = 15 \text{ V. R}_{L} = 0.3 \Omega$		12	20	ns	
Turn-Off Delay Time ^b	t _{d(off)}	V_{DD} = 15 V, R_L = 0.3 Ω $I_D \cong$ 50 A, V_{GEN} = 10 V, R_g = 2.5 Ω		30	45		
Fall Time ^b	t _f			10	15		
Source-Drain Diode Ratings an	d Characteristics	s (T _C = 25°C) ^c	1	•	l	•	
Continuous Current	Is				100		
Pulsed Current	I _{SM}				200	Α	
Forward Voltage ^a	V _{SD}	I _F = 30 A, V _{GS} = 0 V		1.2	1.5	V	
Reverse Recovery Time	t _{rr}	I _F = 50 A, di/dt = 100 A/μs		35	70	ns	

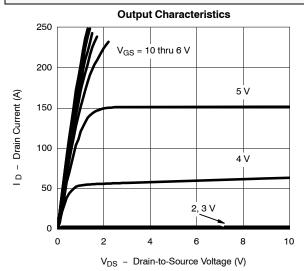
- Notes a. Pulse test; pulse width $\leq 300~\mu s$, duty cycle $\leq 2\%$. b. Independent of operating temperature. c. Guaranteed by design, not subject to production testing.

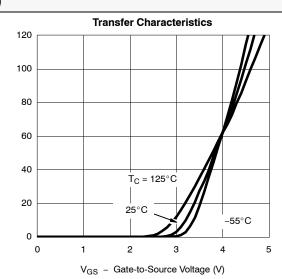




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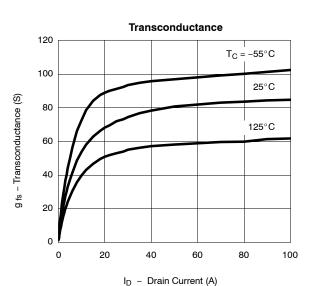
TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

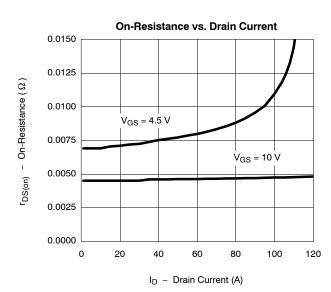


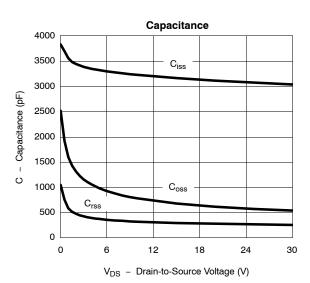


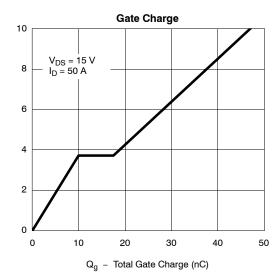
I D - Drain Current (A)

VGS - Gate-to-Source Voltage (V)





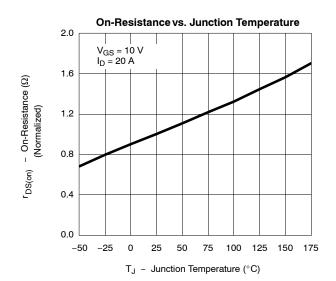


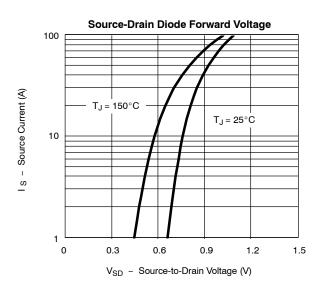


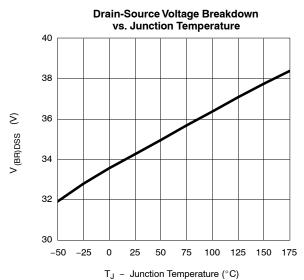
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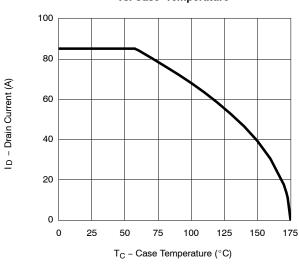


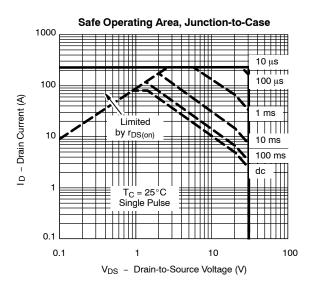


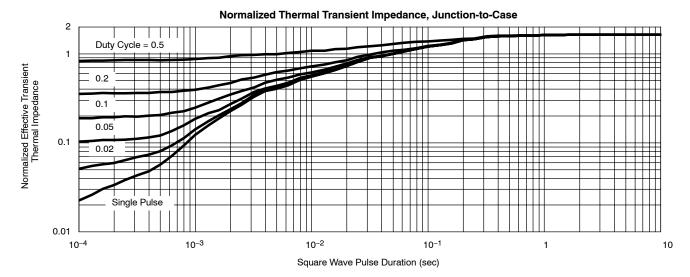
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THERMAL RATINGS

Maximum Avalanche Drain Current vs. Case Temperature









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